PATENT ASSIGNMENT

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 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Makoto KAWAGISHI	02/14/2008
Tsutomu IEKI	02/18/2008
Tadashi KANI	02/19/2008
Satoru NODA	02/19/2008

RECEIVING PARTY DATA

Name:	Murata Manufacturing Co., Ltd.	
Street Address:	10-1 Higashikotari 1-chome	
City:	Nagaokakyo-shi, Kyoto-fu	
State/Country:	JAPAN	
Postal Code:	617-8555	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12041730

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 36856.1632

NAME OF SUBMITTER: Maura Florimonte

Total Attachments: 2

PATENT REEL: 020594 FRAME: 0964

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PATENT REEL: 020594 FRAME: 0965

Attorney Docket No.: 36856.1632

ASSIGNMENT (WORLDWIDE)

WHEREAS we, Makoto KAWAGISHI, Tsutomu IEKI, Tadashi KANI, and Satoru NODA (hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled METHOD FOR MANUFACTURING COMPONENT INCORPORATING MODULE AND COMPONENT INCORPORATING MODULE or which application for Letters Patent of the United States has been executed on even date herewith; X filed on 03/04/08 as Serial No. 12/041,730
WHEREAS, Murata Manufacturing Co., Ltd., 10-1, Higashikotari 1-chome, Nagaokakyo-shi, Kyoto-fu 617-8555, Japan (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor; NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruing by virtue of the International Convention for the Protection of Industrial Property.
ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;
ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.
Dated: 2/14/2008 <u>Makete Kanagishi</u> Maketo KAWAGISHI Dated: 2/18/2008 <u>Tsutomy</u> Leki
Dated: 2/18/2008 Tsutomy Leki Tsutomy Ieki
I SUTOMU IEKI

Dated: 2/19/2008 Tadashie Kani
Tadashi KANI
Dated: 2/19/2008 Jatoru Proda
Satoru NODA

RECORDED: 03/04/2008